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Advances in Welding Techniques, Welding Inspection, and Welding Testing Methods

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Message from the Guest Editors

Dear Colleagues,

Over the years, there have been significant advancements in welding techniques, resulting in improved efficiency, quality, and adaptability. This Special Issue aims to explore and showcase the latest developments in this field, providing a platform for researchers to share their innovative ideas and findings.

The papers included in this Special Issue cover a wide range of topics, including new materials and filler metals, novel welding processes, and advancements in inspection and testing methods. We encourage submissions of original research articles and review papers that explore how these innovations can enhance the overall welding process, resulting in stronger and more reliable joints.

Dr. Chih-Chun Hsieh

Dr. Chunming Lin

Guest Editors



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Special Issue



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Message from the Editor-in-Chief

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